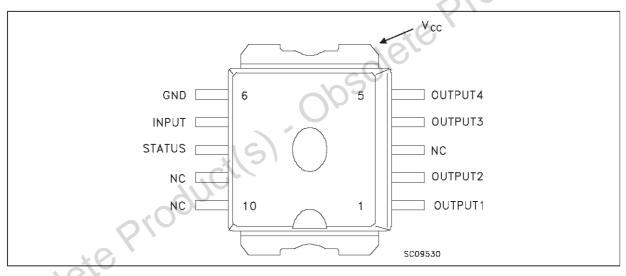
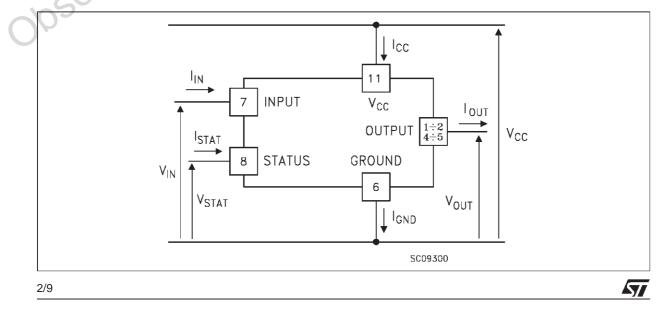
ABSOLUTE MAXIMUM RATING

Symbol	Parameter	Value	Unit
Vcc	Power Supply Voltage (continuous)	45	V
-Vcc	Reverse Supply Voltage (continuous)	-0.3	V
IOUT	Output Current (continuous)	Internally Limited	A
I _R	Reverse Output Current	-25	A
lin	Input Current	±10	mA
ISTAT	Status Pin Current	±10	mA
-I _{GND}	Reverse Ground Current	-200	mA
Vesd	Electrostatic Discharge (1.5 kΩ, 100 pF)	2000	V
Ptot	Power Dissipation at $T_c \le 25$ °C	112	W
Tj	Junction Operating Temperature	-40 to 150	P°C
Tstg	Storage Temperature	-55 to 150	°C
		oroduc	

CONNECTION DIAGRAM



CURRENT AND VOLTAGE CONVENTIONS



ELECTRICAL TRANSIENTS REQUIREMENTS

ISO T/R 7637/1 Test Pulse	TEST LEVELS					
	I	П	111	IV	Delays and Impedance	
1	-25 V	-50 V	-75 V	-100 V	2 ms, 10 Ω	
2	+25 V	+50 V	+75 V	+100 V	0.2 ms, 10 Ω	
3a	-25 V	-50 V	-100 V	-150 V	0.1 μs, 50 Ω	
3b	+25 V	+50 V	+75 V	+100 V	0.1 μs, 50 Ω	
4	-4 V	-5 V	-6 V	-7 V	100 ms, 0.01 Ω	
5	+26.5	+46.5	+66.5	+86.5	400 ms, 2 Ω	
					JUCT(S)	

ISO T/R 7637/1	TEST LEVELS RESULTS			000	
Test Pulse	I	П	111	IV	
1	С	С	С	С	
2	С	С	С	С	
3a	С	С	C	С	
3b	С	С	С	С	
4	С	С	С	С	
5	С	E	E	E	

(With a series resistor $\ge 1 \text{ K}\Omega$ in input and status pins).

CLASS	CONTENTS
С	All function of the device are performed as designed after exposure to disturbance.
E	One or more functions of the device is not performed as designed after exposure and cannot be returned to proper operation without replacing the device.
2105010	

THERMAL DATA

R _{thj-case}	Thermal Resistance Junction-case	Max	1.1	°C/W
R _{thj-a(*)}	Thermal Resistance Junction-ambient	Max	50	°C/W
(+) \//hop mou	ted using minimum recommended and size on EP 4 board			

(*) When mounted using minimum recommended pad size on FR-4 board.

ELECTRICAL CHARACTERISTICS (V_{CC} = 13 V; -40 $^{\circ}$ C < T_J < 125 $^{\circ}$ C unless otherwise specified) POWER

Symbol	Parameter	Test (Conditions	Min.	Тур.	Max.	Unit
Vcc	Operating Supply Voltage			5.5	13	36	V
V_{usd}	Under Voltage Shut Down			3	4	5.5	SY
Vov	Overvoltage Shut Down			36	39	45	V
Ron	On State Resistance	I _{OUT} = 5 A I _{OUT} = 5 A	T _J = 25 °C		9,	20 36	mΩ mΩ
Is	Supply Current	Off state On State	$T_{Case} = 25 \ ^{\circ}C$	21	15 1.4	30 3.3	μA mA
OGIC INF	PUT		olete)			

LOGIC INPUT

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
VIL	Input Low Level Voltage	(*)			1.5	V
VIH	Input High Level Voltage (see note 1)	(*)	3.5			V
V _{I(hyst.)}	Input Hysteresis Voltage		0.2	0.85	1.5	V
I _{IN}	Input Current	$V_{IN} = 5 V$ $T_{case} = 25 °C$			100	μΑ
VICL	Input Clamp Voltage	I _{IN} = 10 mA I _{IN} = -10 mA	5	6 -0.7	7	V V

(*) : The input voltage is internally clamped at 6 V about. It is possible to connect this pin to an higher voltage via an external resistor provided the input current does not exceed 10 mA.

SWITCHING (Vcc = 13 V)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on Delay Time Of Output Current	$I_{OUT} = 5 A$ Resistive Load Input Rise Time < 0.1 μ s T _j = 25 °C	25	90	250	μs
tr	Rise Time Of Output Current	$I_{OUT} = 5 A$ Resistive Load Input Rise Time < 0.1 μ s T _j = 25 °C	80	300	650	μs
t _{d(off)}	Turn-off Delay Time Of Output Current	$I_{OUT} = 5 A$ Resistive Load Input Rise Time < 0.1 μ s T _j = 25 °C	300	750	1500	μs
t _f	Fall Time Of Output Current	$I_{OUT} = 5 A$ Resistive Load Input Rise Time < 0.1 μ s T _j = 25 °C	80	200	400	μs
(di/dt) _{on}	Turn-on Current Slope	I _{OUT} = 5 A		0.02	0.05	A/μs
(di/dt) _{off}	Turn-off Current Slope	I _{OUT} = 5 A		0.02	0.05	A/μs

57

ELECTRICAL CHARACTERISTICS (continued)

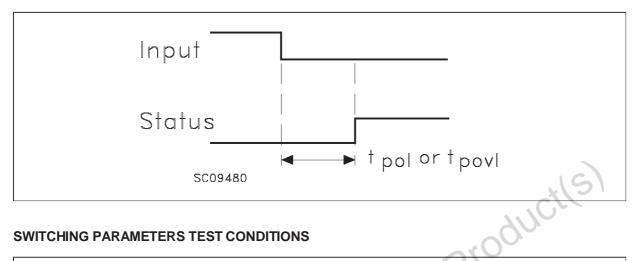
PROTECTIONS AND DIAGNOSTICS

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
T _{TSD}	Thermal Shut-down Temperature		150	170	190	°C
T_{TR}	Thermal Reset Temperature		135			°C
T _{RSD} (HYST)	Thermal Hysteresis		5	15	50	°C
V _{ENOL}	Output Voltage Authorizing Openload Detection	8V≤V _{CC} ≤30V	5.2	6.6	8	V
I _{OL}	Open Load Current Level	8V≤V _{CC} ≤30V	100	800	1500	mA
I _{OV}	Over Current	$R_{LOAD} \le 10 m\Omega$ - 40°C <t<sub>Case<125°C</t<sub>	25	50	<u>}</u>	A
I _{AV}	Average Current in Short Circuit	$ \begin{array}{l} R_{LOAD} \leq \! 10 \ m\Omega \\ T_{C} = 85^{\circ}C \end{array} $	25	5.4		A
V _{STAT}	Status Output Voltage	I _{STAT} = 1.6 mA (Fault Condition)	1		0.4	V
V _{SCL}	Status Clamp Voltage	I _{STAT} = 10 mA I _{STAT} = -10 mA	5.5	6 -0.7	7	V V
t _{POL}	Status Delay	(*)	50	300	950	μs
tpovl	Status Delay	(*)			10	μs
Vdemag	Turn-off Output Clamp Voltage	$I_{OUT} = 5 \text{ A}, L = 1 \text{ mH}, V_{IN} = 0$	V _{CC} -45	V _{cc} -50	V _{CC} -55	V

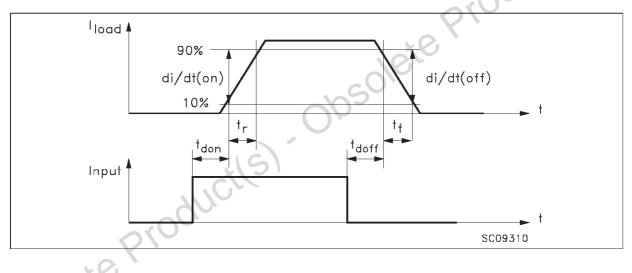
(*) ISO definitions T_{POL} = Status delay in case of open load conditions T_{POVL} = Status delay in case of over load conditions ase of ay in case of consolete Proof



FIGURE 1



SWITCHING PARAMETERS TEST CONDITIONS



TRUTH TABLE

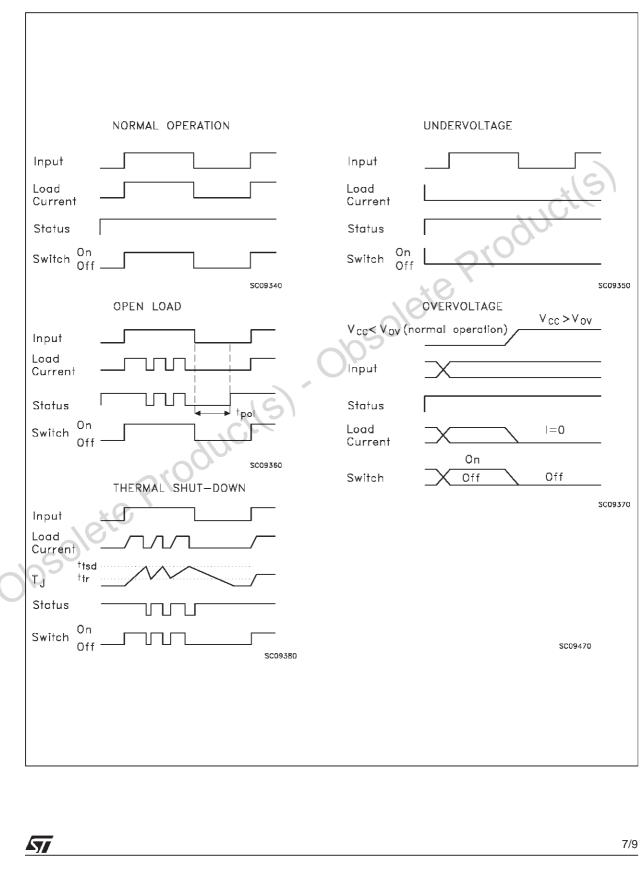
Conditions	INPUT	OUTPUT	STATUS
Normal Operation	L H	L H	H H
Over-voltage	X	L	Н
Under-voltage	X	L	Н
Thermal shut-down	н	L	L
Open load	Н	Н	L

57

H = high level, L= low level, X= unspecified

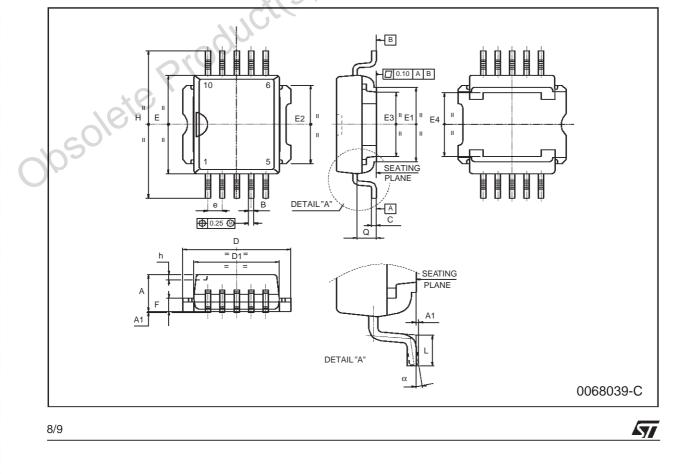
VN460SP





VN460SP

DIM.		mm			inch			
DIN.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.		
А	3.35		3.65	0.132		0.144		
A1	0.00		0.10	0.000		0.004		
В	0.40		0.60	0.016		0.024		
С	0.35		0.55	0.013		0.022		
D	9.40		9.60	0.370		0.378		
D1	7.40		7.60	0.291		0.300		
E	9.30		9.50	0.366		0.374		
E1	7.20		7.40	0.283		0.291		
E2	7.20		7.60	0.283	6	0.300		
E3	6.10		6.35	0.240	~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~~	0.250		
E4	5.90		6.10	0.232		0.240		
е		1.27		× 0,	0.050			
F	1.25		1.35	0.049		0.053		
Н	13.80		14.40	0.543		0.567		
h		0.50		2	0.002			
L	1.20		1.80	0.047		0.071		
q		1.70			0.067			
α	0°		8°					



Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

ST PRODUCTS ARE NOT DESIGNED OR AUTHORIZED FOR USE IN: (A) SAFETY CRITICAL APPLICATIONS SUCH AS LIFE SUPPORTING, ACTIVE IMPLANTED DEVICES OR SYSTEMS WITH PRODUCT FUNCTIONAL SAFETY REQUIREMENTS; (B) AERONAUTIC APPLICATIONS; (C) AUTOMOTIVE APPLICATIONS OR ENVIRONMENTS, AND/OR (D) AEROSPACE APPLICATIONS OR ENVIRONMENTS, WHERE ST PRODUCTS ARE NOT DESIGNED FOR SUCH USE, THE PURCHASER SHALL USE PRODUCTS AT PURCHASER'S SOLE RISK, EVEN IF ST HAS BEEN INFORMED IN WRITING OF SUCH USAGE, UNLESS A PRODUCT IS EXPRESSLY DESIGNATED BY ST AS BEING INTENDED FOR "AUTOMOTIVE, AUTOMOTIVE SAFETY OR MEDICAL" INDUSTRY DOMAINS ACCORDING TO ST PRODUCT DESIGN SPECIFICATIONS. PRODUCTS FORMALLY ESCC, QML OR JAN QUALIFIED ARE DEEMED SUITABLE FOR USE IN AEROSPACE BY THE CORRESPONDING GOVERNMENTAL AGENCY.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries. Information in this document supersedes and replaces all information previously supplied. The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2013 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Philippines - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com



DocID5691 Rev 3